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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/786,807	02/25/2004	Hui-Mei Chen	MEG02-005	3341
7:	590 12/14/2006		EXAMINER AU, BAC H	
GEORGE O.				
28 DAVIS AVENUE POUGHKEEPSIE, NY 12603		•	ART UNIT	PAPER NUMBER
TOOGINEELI	3, 111 12000		2822	
			DATE MAILED: 12/14/200	6

Please find below and/or attached an Office communication concerning this application or proceeding.

The MAILING DATE of this communication appear Period for Reply  A SHORTENED STATUTORY PERIOD FOR REPLY IS WHICHEVER IS LONGER, FROM THE MAILING DATE - Extensions of time may be available under the provisions of 37 CFR 1.136(a) after SIX (6) MONTHS from the mailing date of this communication If NO period for reply is specified above, the maximum statutory period will ap - Failure to reply within the set or extended period for reply will, by statute, cau Any reply received by the Office later than three months after the mailing date earned patent term adjustment. See 37 CFR 1.704(b).  Status  1) Responsive to communication(s) filed on 28 September 28 September 29 Septe	S SET TO EXPIRE 3 MONTHOME OF THIS COMMUNICATION. In no event, however, may a reply be timely and will expire SIX (6) MONTHS from use the application to become ABANDONE of this communication, even if timely filed the ember 2006. Ition is non-final. The except for formal matters, proparte Quayle, 1935 C.D. 11, 4. Splication.	(S) OR THIRTY (30) DAYS, N. mely filed In the mailing date of this communication. ED (35 U.S.C. § 133). d, may reduce any
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closed in accordance with the practice under Ex p		
Disposition of Claims		
4) ⊠ Claim(s) 15,17,27 and 30 is/are pending in the ap 4a) Of the above claim(s) is/are withdrawn for the apove claim(s) is/are allowed.  5) □ Claim(s) 15,17,27 and 30 is/are rejected.  7) □ Claim(s) is/are objected to.  8) □ Claim(s) are subject to restriction and/or elections.	·	·
Application Papers		•
9) ☐ The specification is objected to by the Examiner.  10) ☑ The drawing(s) filed on 25 February 2004 is/are: a Applicant may not request that any objection to the draw Replacement drawing sheet(s) including the correction  11) ☐ The oath or declaration is objected to by the Exam	wing(s) be held in abeyance. Se is required if the drawing(s) is ob	e 37 CFR 1.85(a). ojected to. See 37 CFR 1.121(d).
Priority under 35 U.S.C. § 119		
12) Acknowledgment is made of a claim for foreign price a) All b) Some * c) None of:  1. Certified copies of the priority documents has 2. Certified copies of the priority documents has 3. Copies of the certified copies of the priority application from the International Bureau (P	ave been received. ave been received in Applicat documents have been receive PCT Rule 17.2(a)).	ion No ed in this National Stage
Attachment(s)  1) Notice of References Cited (PTO-892)  2) Notice of Draftsperson's Patent Drawing Review (PTO-948)  3) Information Disclosure Statement(s) (PTO/SB/08)	4) Interview Summary Paper No(s)/Mail D 5) Notice of Informal I 6) Other:	ate

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### **DETAILED ACTION**

# Response to Amendment

1. Applicant's amendment dated September 28, 2006 in which claims 15, 17, 27 and 30 were amended has been entered.

### Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 2. Claims 15, 17, 27, and 30 are rejected under 35 U.S.C. 102(b) as being anticipated by Tsukamoto (U.S. Pat. 5554859).

Regarding claims 15, 17, 27, and 30, Tsukamoto [Figs.3A-B] discloses a method for fabricating a semiconductor wafer with a patterned contact point [3007; col.19 lines 17-20] comprising gold, comprising:

ion milling said patterned contact point for cleaning said patterned contact point; wherein said ion milling said patterned contact point comprises using argon [Col.19 lines 22-23];

a method for fabricating a semiconductor wafer, comprising:

depositing a patterned metal bump [3007] on a topmost patterned circuit layer of said semiconductor wafer, wherein said patterned metal bump has a substantially flat top surface; and

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ion milling said patterned metal bump for cleaning said metal bump [Col.19 lines 22-23];

wherein said ion milling said patterned metal bump comprises using argon [Col.19 lines 22-23].

# Response to Arguments

3. Applicant's arguments filed September 28, 2006 have been fully considered but they are not persuasive. Applicant states that the ion milling process of Tsukamoto does not disclose cleaning the patterned contact point or metal bump. This is respectfully traversed. The ion milling process of Tsukamoto does disclose cleaning the patterned contact point or metal bump at least because the process removes extraneous undesired gold layer in order to form the desired shape. In any case, the scope of the claim is not limited to a cleaning process because the limitation "for cleaning said patterned contact point (metal bump)" is an intended use of the ion milling process, and the ion milling process of Tsukamoto is capable of being utilized for the intended use. Applicant's arguments are not persuasive, and therefore the rejection is maintained and is made final.

### Conclusion

4. **THIS ACTION IS MADE FINAL.** Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

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A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Bac H. Au whose telephone number is 571-272-8795. The examiner can normally be reached on Mon-Fri 8-5.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Zandra Smith can be reached on 571-272-2429. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

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Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

**BHA** 

Zandra V. Smith